

MH182 Specifications Multi-Purpose Hall Effect Latch

MH182 Hall-Effect sensor is a temperature stable, stress-resistant latch. Superior high-temperature performance is made possible through a dynamic offset cancellation that utilizes chopper-stabilization. This method reduces the offset voltage normally caused by device over molding, temperature dependencies, and thermal stress.

MH182 includes the following on a single silicon chip: voltage regulator, Hall voltage generator, small-signal amplifier, chopper stabilization, Schmitt trigger, open-drain output. Advanced CMOS wafer fabrication processing is used to take advantage of low-voltage requirements, component matching, very low input-offset errors, and small component geometries.

This device requires the presence of both south and north polarity magnetic fields for operation. In the presence of a south polarity field of sufficient strength, the device output latches on, and only switches off when a north polarity field of sufficient strength is present.

MH182 is rated for operation between the ambient temperatures -40°C and 85°C for the E temperature range, and -40°C to 125°C for the K temperature range. The two package styles available provide magnetically optimized solutions for most applications. Package SO is an SOT-23, a miniature low-profile surface-mount package, while package UA is a three-lead ultra mini SIP for through-hole mounting.

The package type is in a Halogen Free version was verified by third party Lab.

Features and Benefits

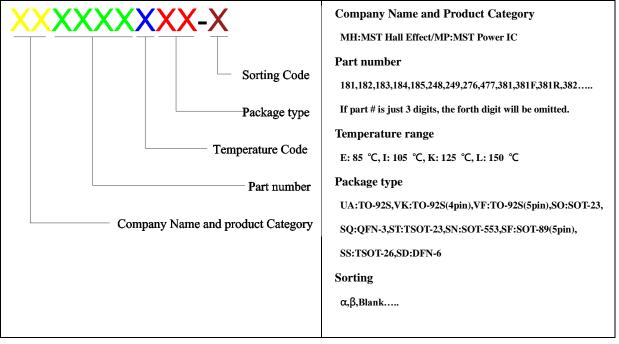
- Chopper stabilized amplifier stage
- Optimized for BLDC motor applications
- New miniature package / thin, high reliability package
- Operation down to 3.0V
- 100% tested at 125 °C for K.
- Custom sensitivity / Temperature selection are available.
- RoHS compliant 2011/65/EU and Halogen Free

Applications

- High temperature Fan motor
- 3 phase BLDC motor application
- Speed sensing
- Position sensing
- Current sensing
- Revolution counting
- Solid-State Switch
- Linear Position Detection
- Angular Position Detection
- Proximity Detection



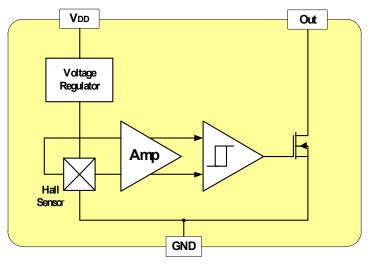
Ordering Information



Part No.	Temperature Suffix	Package Type	
MH182KUA	K (-40°C to + 125°C)	UA (TO-92S)	
MH182KSO	K (-40°C to $+ 125$ °C)	SO (SOT-23)	
MH182EUA	E (-40°C to + 85°C)	UA (TO-92S)	
MH182ESO	$E (-40^{\circ}C \text{ to} + 85^{\circ}C)$	SO (SOT-23)	

KUA spec is using in industrial and automotive application. Special Hot Testing is utilized.

Functional Diagram





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Absolute Maximum Ratings At (Ta=25 °C)

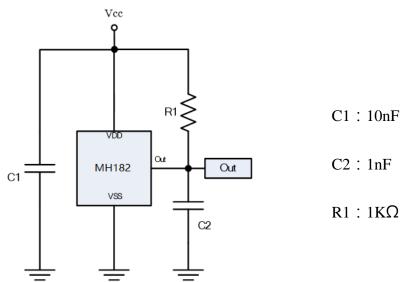
Characteristics			Values	Unit	
Supply voltage,(V _{DD})			26	V	
Output Voltage,(Vout)			26	V	
Reverse voltage, (V _{DD}) (V _{OUT})			-0.3	V	
Output current, (<i>I</i> _{OUT})			50	mA	
		"E" version	-40 to +85	°C	
Operating Temperature Range, (<i>[1a]</i>	"K" version	-40 to +125	°C	
Storage temperature range, (<i>Ts</i>)			-65 to +150	°C	
Maximum Junction Temp,(<i>Tj</i>)			150	°C	
Thermal Resistance	(Hja	a) UA / SO	206 / 543	°C/W	
	(θjc) UA / SO		148 / 410	°C/W	
Package Power Dissipation, (P_D) UA / SO			606 / 230	mW	

Note: Do not apply reverse voltage to V_{DD} and V_{OUT} Pin, It may be caused for Miss function or damaged device.

Electrical Specifications

DC Operating Parameters: $T_A = +25 ^{\circ}C$, $V_{DD} = 12V$								
Parameters	Test Conditions	Min	Тур	Max	Units			
Supply Voltage,(V _{DD})	Operating	3.0		24.0	V			
Supply Current,(<i>I</i> _{DD})	B <bop< td=""><td></td><td></td><td>5.0</td><td>mA</td></bop<>			5.0	mA			
Output Saturation Voltage, (V _{sat})	IOUT = $10 \text{ mA}, \text{B} > \text{Bop}$			400.0	mV			
Output Leakage Current, (Ioff)	IOFF B <brp, vout="<math">12V</brp,>			15.0	uA			
Output Rise Time, (<i>T</i> _R)	RL=820 Ω , CL =20pF			0.45	uS			
Output Fall Time, (<i>T_F</i>)	RL=820 \Omega; CL =20pF			0.45	uS			
Operate Point,(<i>Bop</i>)		10		60	Gauss			
Release Point,(<i>BRP</i>)		-60		-10	Gauss			
Hysteresis,(BHYS)			80		Gauss			

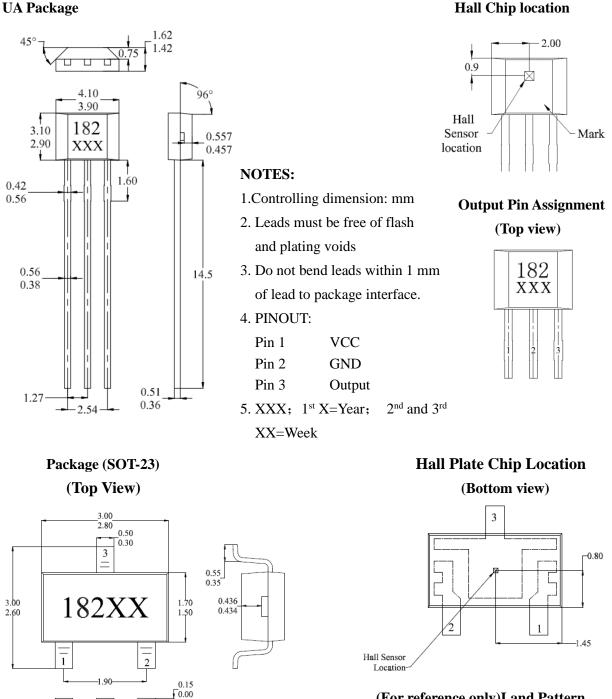
Typical application circuit



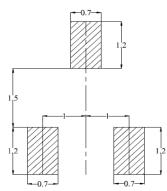


Sensor Location, Package Dimension and Marking

Hall Chip location



(For reference only)Land Pattern



NOTES:

- 1. PINOUT (See Top View at left :) Pin 1 :V_{DD;} Pin 2: Output ; Pin 3 GND
- Controlling dimension: mm 2.
- 3. Lead thickness after solder plating will be 0.254mm maximum

1.25 0.90

4. XX: Date Code, Refer to DC table